



## 40V P-Channel Trench Power MOSFET

### General Description

The SJL40P300 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as -4.5V. This device is suitable for use as a wide variety of applications.

### Features

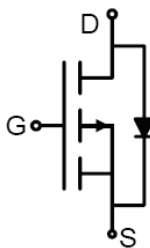
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handling capability
- Lead free product is acquired

### Application

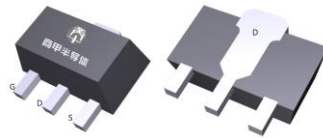
- PWM Applications
- Load Switch
- Power Management

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	-40	V
$R_{DS(ON\_TYP)}$	35	m $\Omega$
$I_D$	-7	A
$Q_G$	19.6	nC



Schematic Diagram



SOT-89-3L top&bottom view



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJL40P300	SJL40P300	SOT-89-3L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	-40	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_A=25^\circ\text{C}$ )	-7	A
	Drain Current-Continuous( $T_A=100^\circ\text{C}$ )	-4.4	A
$I_{DM}$ (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-28	A
$P_D$	Maximum Power Dissipation( $T_A=25^\circ\text{C}$ )	3.7	W
	Maximum Power Dissipation( $T_A=100^\circ\text{C}$ )	1.5	W
$E_{AS}$	Avalanche energy (Note 2)	109	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		34	$^\circ\text{C}/\text{W}$



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**Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-40			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =-40V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃			-1	μA
		V <sub>DS</sub> =-40V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			-100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA	-1		-2.5	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =-5V, I <sub>D</sub> =-10A		15		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =-10V, I <sub>D</sub> =-10A T <sub>J</sub> =25℃		35	44	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-5A T <sub>J</sub> =25℃		45.7	60.8	mΩ
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-20V, V <sub>GS</sub> =0V, f=1.0MHz		1021		pF
C <sub>oss</sub>	Output Capacitance			63.6		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			48.6		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		4.7		Ω
Switching Parameters						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V, R <sub>L</sub> =2Ω, R <sub>GEN</sub> =3Ω		13		nS
t <sub>r</sub>	Turn-on Rise Time			16		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			180		nS
t <sub>f</sub>	Turn-Off Fall Time			86		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =-10V, V <sub>DS</sub> =-20V, I <sub>D</sub> =-10A		19.3		nC
Q <sub>gs</sub>	Gate-Source Charge			2.5		nC
Q <sub>gd</sub>	Gate-Drain Charge			5.5		nC
Source-Drain Diode Characteristics						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				-7	A
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =-10A			-1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =-10A, dI/dt=100A/μs		34		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =-10A, dI/dt=100A/μs		35		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

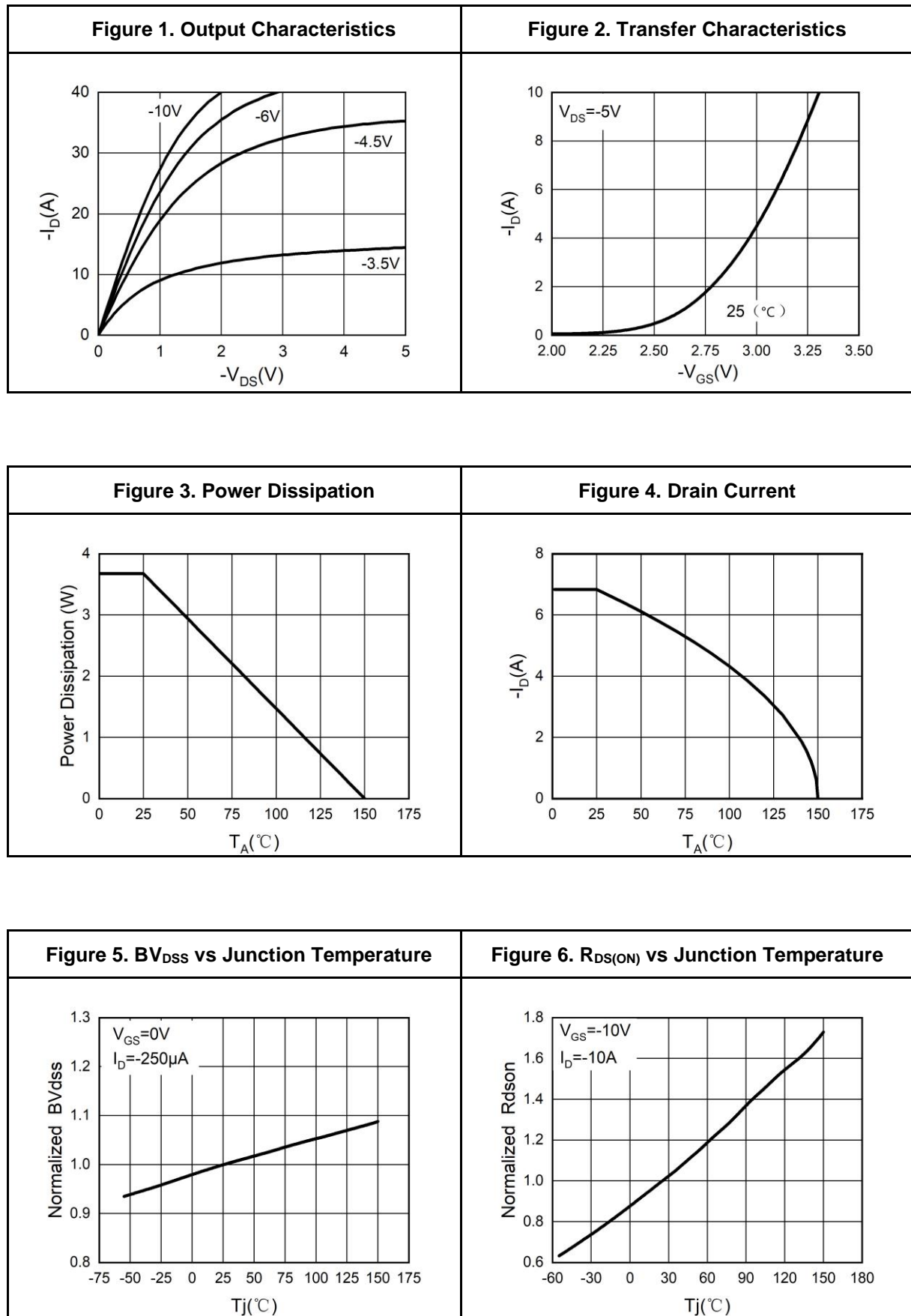
Notes 2.EAS condition:  $T_J=25^{\circ}\text{C}, V_{DD}=40V, V_G=-10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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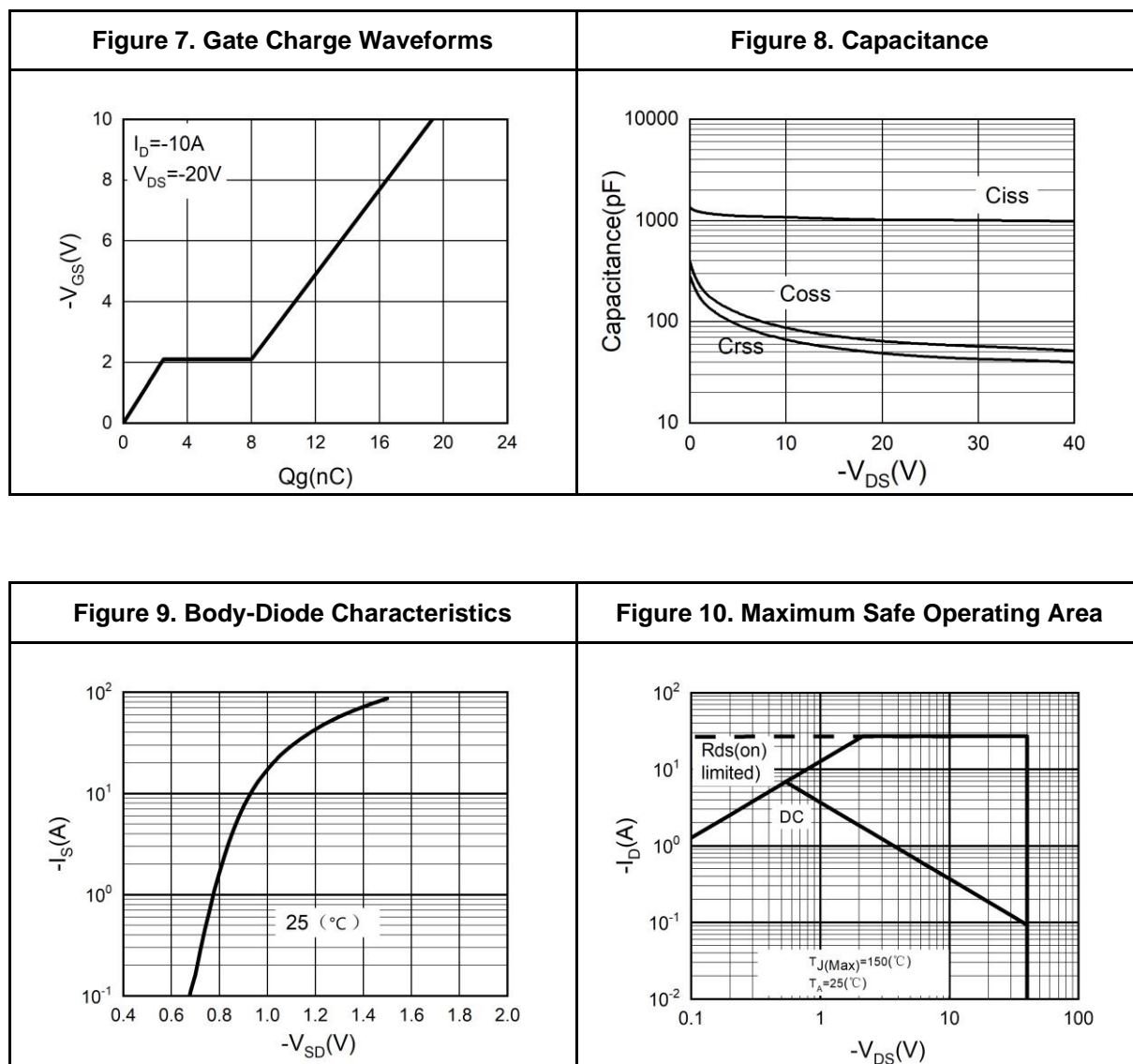
### Typical Electrical And Thermal Characteristics (Curves)





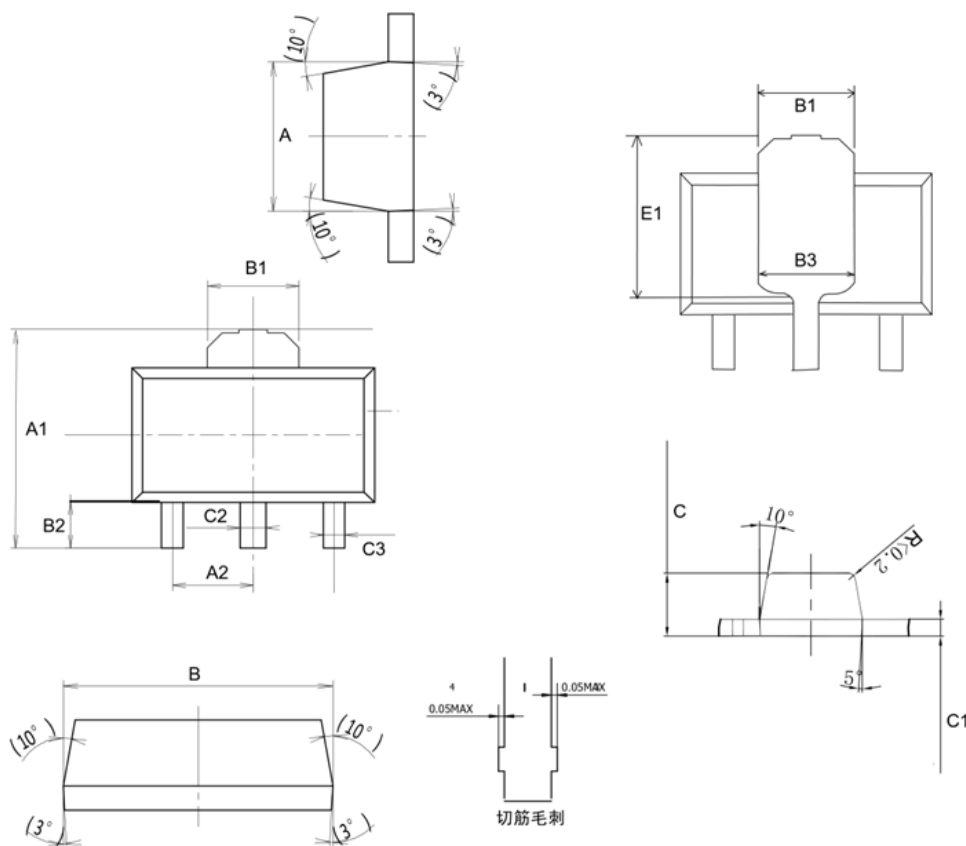
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### Typical Electrical And Thermal Characteristics (Curves)





## SOT-89-3L Package Information



COMMON DIMENSIONS UNITS: MEASURE=MILLIMETER			
SYMBOL	MIN	MID	MAX
A	2.35	2.45	2.55
A1	4.135	4.235	4.335
A2	1.45	1.50	1.55
B	4.40	4.50	4.60
B1		1.55 REF	
B2	0.95	1.00	1.05
B3		1.63 REF	
C	1.45	1.50	1.55
C1	0.39	0.40	0.41
C2	0.4	0.48	0.55
C3	0.35	0.4	0.45
E1	2.65	2.75	2.85



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